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Power MOSFET

■ GENERAL DESCRIPTION

The XP162A11C0PR-G is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. A gate protect diode is built-in to prevent static damage. The small SOT-89 package makes high density mounting possible.

■ APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■ FEATURES

Low On-State Resistance : $R_{ds(on)} = 0.15\Omega @ V_{gs} = -10V$
: $R_{ds(on)} = 0.28\Omega @ V_{gs} = -4.5V$

Ultra High-Speed Switching

Driving Voltage : -4.5V

Gate Protect Diode Built-in

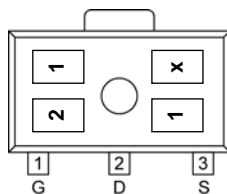
P-Channel Power MOSFET

DMOS Structure

Small Package : SOT-89

Environmentally Friendly : EU RoHS Compliant, Pb Free

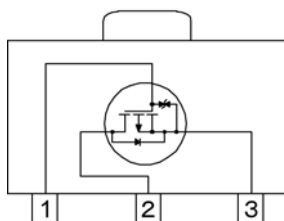
■ PIN CONFIGURATION/MARKING



SOT-89
(TOP VIEW)

* x represents production lot number.

■ EQUIVALENT CIRCUIT



P-channel MOSFET
(1 device built-in)

■ PRODUCT NAME

PRODUCTS	PACKAGE	ORDER UNIT
XP162A11C0PR	SOT-89	1,000/Reel
XP162A11C0PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	V _{dss}	-30	V
Gate-Source Voltage	V _{gss}	±20	V
Drain Current (DC)	I _d	-2.5	A
Drain Current (Pulse)	I _{dp}	-10	A
Reverse Drain Current	I _{dr}	-2.5	A
Channel Power Dissipation *	P _d	2	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55~150	°C

* When implemented on a ceramic PCB

ELECTRICAL CHARACTERISTICS

DC Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	Idss	Vds= -30V, Vgs= 0V	-	-	-10	μA
Gate-Source Leak Current	Igss	Vgs= ±20V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= -1mA, Vds= -10V	-1.0	-	-2.5	V
Drain-Source On-State Resistance*1	Rds(on)	Id= -1.5A, Vgs= -10V	-	0.11	0.15	Ω
		Id= -1.5A, Vgs= -4.5V	-	0.20	0.28	Ω
Forward Transfer Admittance*1	Yfs	Id= -1.5A, Vds= -10V	-	2.5	-	S
Body Drain Diode Forward Voltage	Vf	If= -2.5A, Vgs= 0V	-	-0.85	-1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= -10V, Vgs=0V f= 1MHz	-	280	-	pF
Output Capacitance	Coss		-	200	-	pF
Feedback Capacitance	Crss		-	90	-	pF

Switching Characteristics

Ta = 25°C

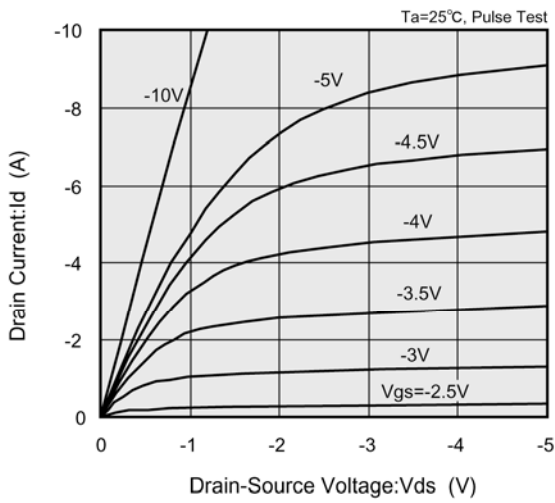
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= -5V, Id= -1.5A Vdd= -10V	-	10	-	ns
Rise Time	tr		-	30	-	ns
Turn-Off Delay Time	td (off)		-	20	-	ns
Fall Time	tf		-	35	-	ns

Thermal Characteristics

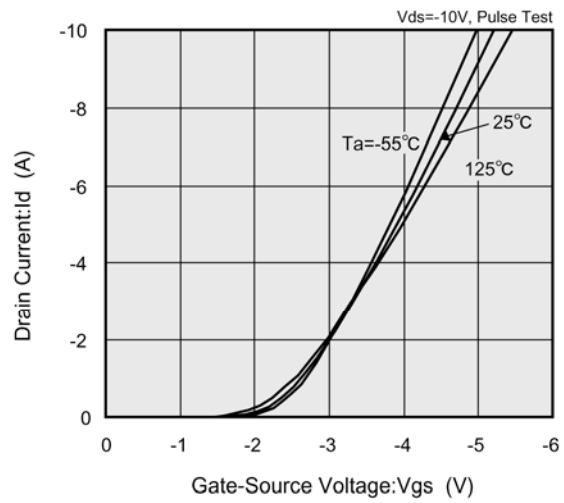
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS

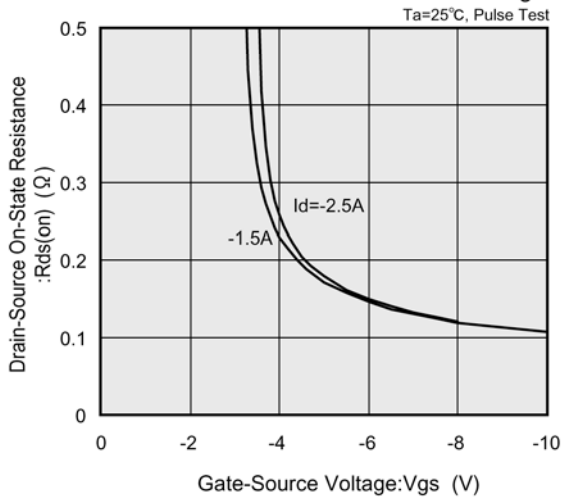
(1) Drain Current vs. Drain-Source Voltage



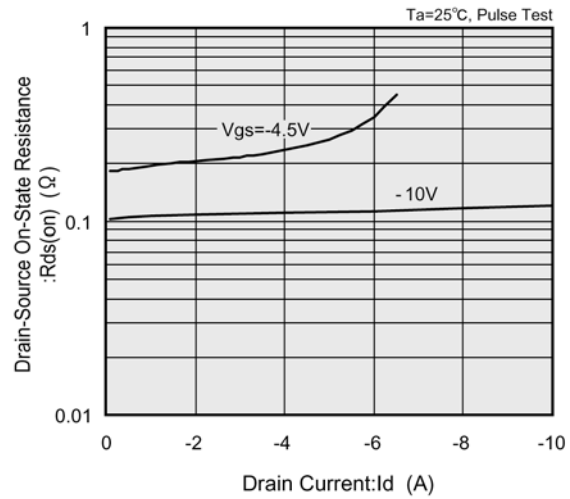
(2) Drain Current vs. Gate-Source Voltage



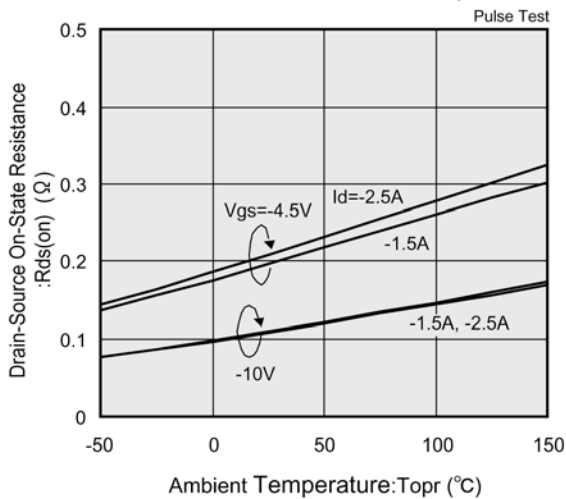
(3) Drain-Source On-State Resistance vs. Gate-Source Voltage



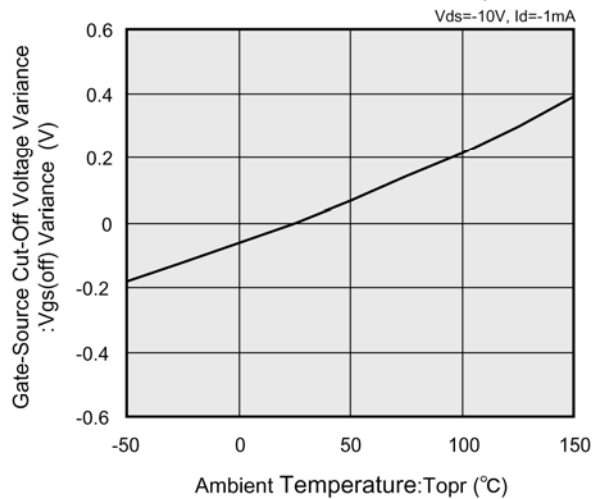
(4) Drain-Source On-State Resistance vs. Drain Current



(5) Drain-Source On-State Resistance vs. Ambient Temperature

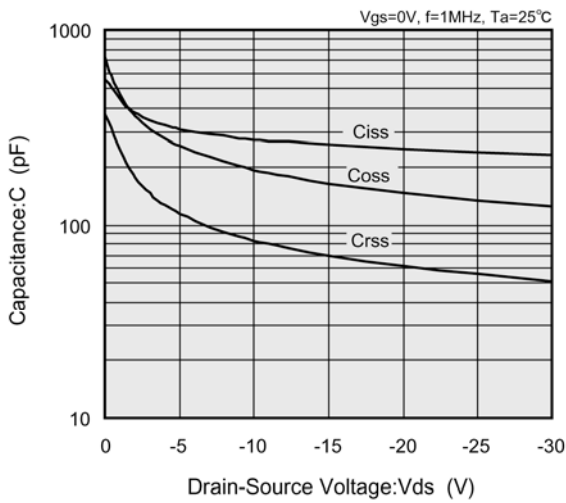


(6) Gate-Source Cut-Off Voltage Variance vs. Ambient Temperature

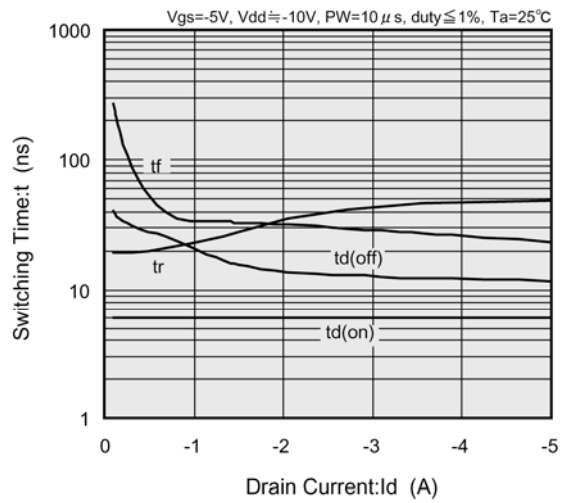


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

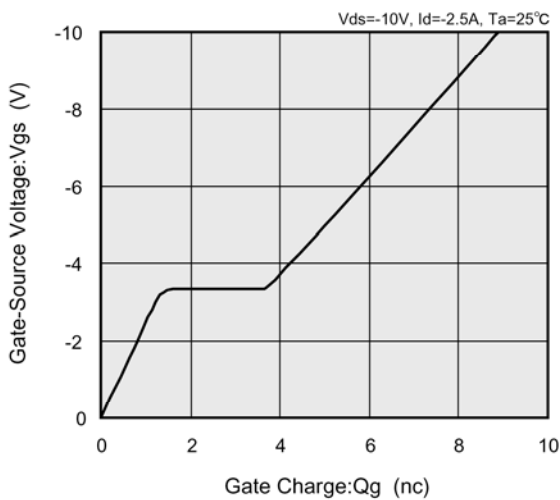
(7) Capacitance vs. Drain-Source Voltage



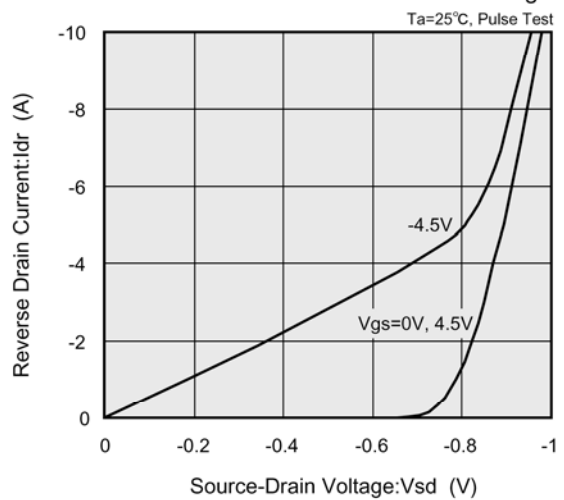
(8) Switching Time vs. Drain Current



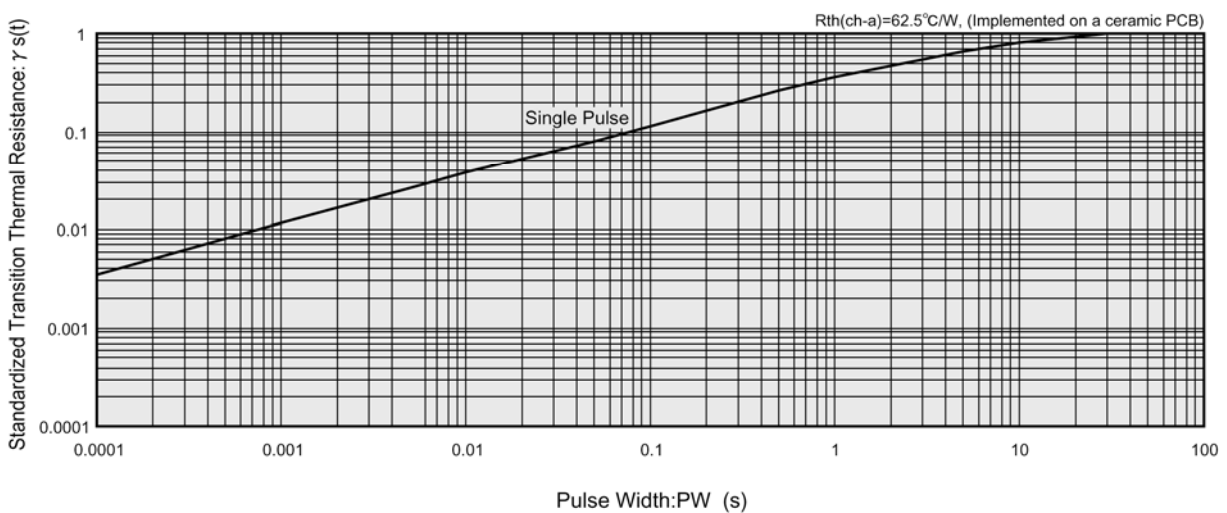
(9) Gate-Source Voltage vs. Gate Charge



(10) Reverse Drain Current vs. Source-Drain Voltage



(11) Standardized transition Thermal Resistance vs. Pulse Width



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